

PATENT PATENT Attorney Docket No.: SAM 2164 OCC / 2002

IN THE UNITED STATES PATENT AND TRADEMARK OFFICE

Serial No.:

Applicant(s): Myeong-cheol Kim, et al.

09/731,385

Filing Date:

Title:

December 6, 2000

SEMICONDUCTOR DEVICE HAVING SELF-ALIGNED CONTACT AND

FABRICATING METHOD THEREFOR

CERTIFICATE OF MAILING UNDER 37 C.F.R. § 1.8

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Lisa Sanders

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Group Art Unit: 2811

BOX AF

Assistant Commissioner for Patents

Washington, D.C. 20231

<u>AMENDMENT AFTER FINAL REJECTION</u>

Sir:

This is in response to the final Office Action mailed on September 3, 2002. It is requested that the following amendments be entered and that the following remarks be considered.

Please amend the application as follows:

In the Claims

(Amended) A semiconductor device having a self-aligned contact, the 1. semiconductor device comprising:

a plurality of conductive patterns formed to be adjacent to one another by sequentially stacking and patterning a first conductive layer and a mask layer on a particular underlying layer;

a first insulation layer filling a gap between adjacent conductive patterns, the first insulation layer being formed of a first insulating material;

a second insulation layer having a spacer shape, the second insulation layer formed at the